# SD3118

# Low profile power inductors



### Description

- · Low profile shielded drum core
- · Compact footprint utilizes less board space
- Inductance Range from 1.0µH to 1,000µH
- Current range from 0.083 to 2.94 amps
- 3.2 x 3.2mm footprint surface mount package in a 1.8mm height
- Ferrite core material
- · Halogen free, lead free, RoHS compliant

### **Applications**

- · Mobile/smart phones
- · Tablets/e-readers
- Media players
- · Digital cameras
- · Small LED driver and LCD displays
- Handheld/mobile equipment

### **Environmental Data**

- Storage temperature range (Component): -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient + self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant









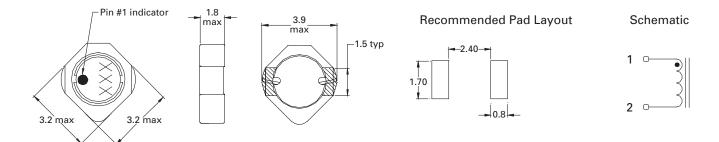
# **Product Specifications**

Part Number <sup>6</sup>	ОСL¹ (µH)	Part marking designator	I <sub>rms</sub> ² (amps)	l <sup>3</sup> (amps)	DCR (Ω) typical @ +20°C	K-factor⁴
SD3118-1R0-R	1.04±30%	А	2.01	3.07	0.041	84
SD3118-1R5-R	1.44±30%	В	1.81	2.42	0.051	68
SD3118-2R2-R	2.12±30%	С	1.50	2.00	0.074	57
SD3118-3R3-R	3.36±30%	D	1.22	1.59	0.11	56
SD3118-4R7-R	4.90±30%	Е	1.02	1.31	0.16	39
SD3118-6R8-R	6.72±30%	F	0.85	1.12	0.23	32
SD3118- 8R2-R	8.10±30%	G	0.81	1.02	0.26	29
SD3118- 100-R	10.4±30%	Н	0.75	0.90	0.30	26
SD3118-150-R	14.9±30%	1	0.62	0.75	0.44	21
SD3118-220-R	22.5±30%	J	0.50	0.61	0.68	18
SD3118-330-R	33.1±30%	K	0.41	0.51	0.99	14
SD3118-470-R	47.5±30%	L	0.37	0.42	1.2	12
SD3118-221-R	222±20%	М	0.182	0.177	4.8	6
SD3118-331-R	330±20%	N	0.146	0.145	7.4	5
SD3118-471-R	470±20%	0	0.130	0.122	9.2	4
SD3118-681-R	680±20%	Р	0.107	0.101	14	3
SD3118-102-R	999±20%	Q	0.087	0.083	21	3

<sup>1.</sup> Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.1Vrms, 0.0Adc, @ +25°C

- 3. I<sub>sat</sub>: Peak current for approximately 30% rolloff @ +20°C
- K-factor: Used to determine B<sub>p-p</sub> for core loss (see graph). Bp-p = K \* L \* Δl. B<sub>p-p</sub>: (mTesla), K: (K-factor from table),
   L: (Inductance in μH), Δl (Peak to peak ripple current in Amps).
- 5. Part Number Definition: SD3118-xxx-R SD3118 = Product code and size
  - xxx =Inductance value in uH, R= decimal point, if no R is present then last character equals number of zeros -R suffix = RoHS compliant

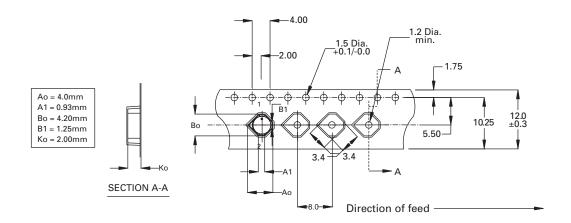
## Dimensions (mm)



<sup>2.</sup> I<sub>ms</sub>: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.

# Packaging information (mm)

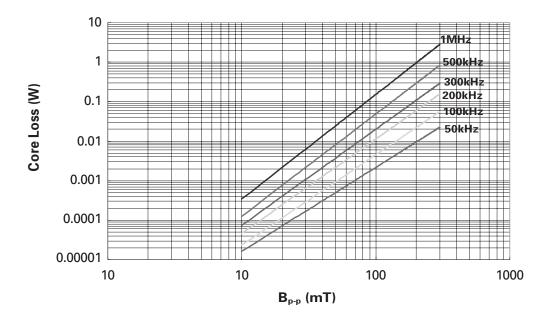
Supplied in tape and reel packaging, 4,100 parts per 13" diameter reel



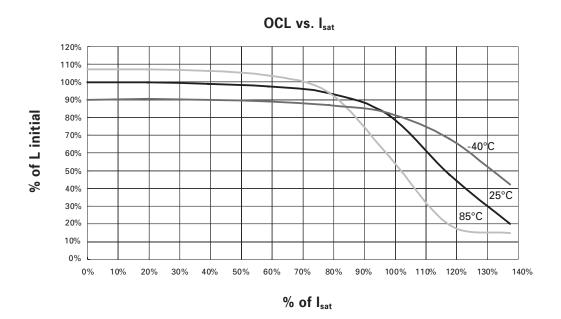
# Temperature rise vs. total loss



# Core loss vs. B<sub>p-p</sub>



#### **Inductance characteristics**



# Solder reflow profile

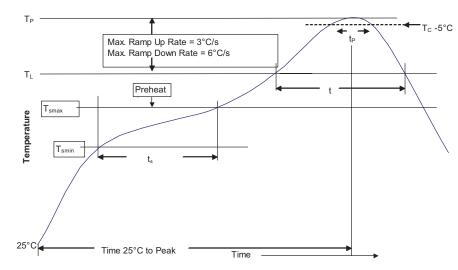


Table 1 - Standard SnPb Solder (T<sub>C</sub>)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T<sub>C</sub>)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

# **Reference JDEC J-STD-020D**

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak • Temperature min. (T <sub>smin</sub> )	100°C	150°C	
• Temperature max. (T <sub>smax</sub> )	150°C	200°C	
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 Seconds	60-120 Seconds	
Average ramp up rate $T_{smax}$ to $T_{p}$	3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL) Time at liquidous (tL)	183°C 60-150 Seconds	217°C 60-150 Seconds	
Peak package body temperature (Tp)*	Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature $(T_c)$	20 Seconds**	30 Seconds**	
Average ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.	

 $<sup>^{*}</sup>$  Tolerance for peak profile temperature (T<sub>p</sub>) is defined as a supplier minimum and a user maximum.

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<sup>\*\*</sup> Tolerance for time at peak profile temperature (t<sub>p</sub>) is defined as a supplier minimum and a user maximum.